

Carrier_BT494030_SOT23-6_h LCP



Part number	78 01 030 0003
Specification	Carrier_BT494030_SOT23-6_h LCP
HARTING eCatalogue	https://harting.com/78010300003

Image is for illustration purposes only. Please refer to product description.

Identification

Category	Surface Mount Device
Series	3D-MID
Element	Carrier for electronic components
Specification	Interconnection
Features	Other materials or trace layouts on request!

Version

Fixing	PCB assembly (SMD)
Pack contents	Tape & reel 3400 pieces on reel
	Lower quantities available on request!

Technical characteristics

Operating temperature	-40 +125 °C
Storage temperature	-40 +125 °C

Material properties

Material	Liquid crystal polymer (LCP)
Surface (contacts)	Au (≥ 0.05 μm) over Ni (≥ 4 μm) over Cu (511 μm)
Length	4.9 mm
Width	4 mm
Height	3 mm
RoHS	compliant
ELV status	compliant

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Material properties

China RoHS	е
REACH Annex XVII substances	Not contained
REACH ANNEX XIV substances	Not contained
REACH SVHC substances	Not contained
California Proposition 65 substances	Not contained

Commercial data

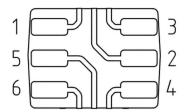
Packaging size	1
Net weight	0.315 g
Country of origin	Switzerland
European customs tariff number	85340090
GTIN	5713140277403
eCl@ss	27469090 PCB connection technology (other, unspecified)
ETIM	EC002637
UNSPSC 24.0	39121415

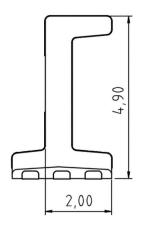
Other materials or trace layouts on request!

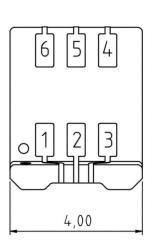


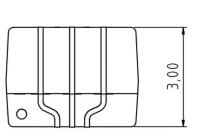


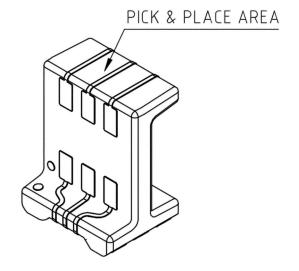
Drawing (dimensions in mm)





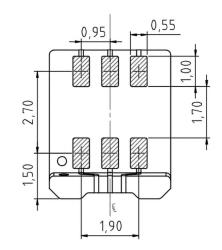




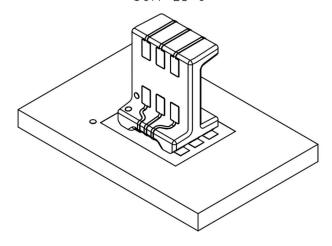


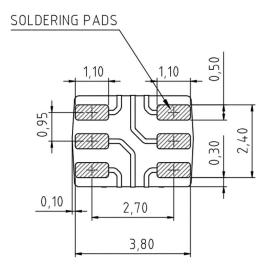


Drawing (dimensions in mm)

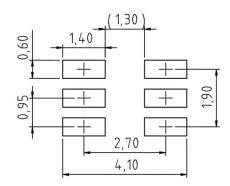


COMPONENT PADS LAYOUT SOIT-23-6





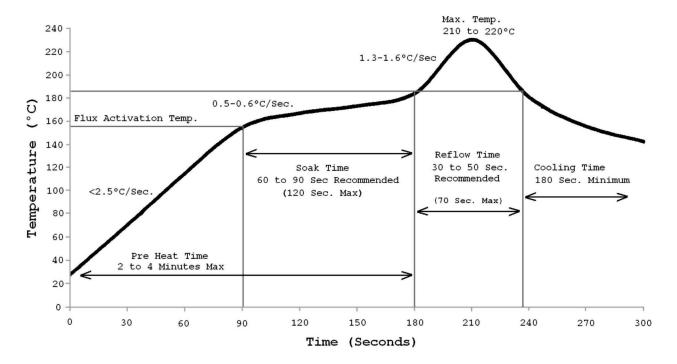
CARRIER PATTERN LAYOUT



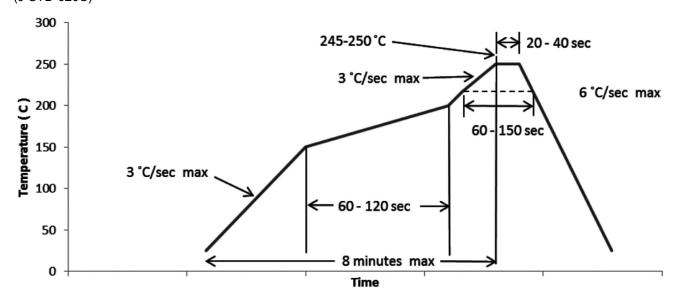
RECOMMENDED PCB PATTERN LAYOUT



Soldering instructions



PB-free soldering profile (J-STD-020C)



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Tape layout & packaging

BT494030

